



**THE DATASHEET OF  
BZD27C36P R3G**



## 1W, 10V - 220V Voltage Regulator Diode

### FEATURES

- Silicon zener diodes
- Low profile surface-mount package
- Zener and surge current specification
- Low leakage current
- Excellent stability
- Moisture sensitivity level: level 1, per J-STD-020
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

### APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter

### MECHANICAL DATA

- Case: Sub SMA
- Molding compound meets UL 94 V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As indicated by Cathode band
- Weight: 19mg (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
$V_Z$	10 - 220	V
$P_{tot}$	1.0	W
$T_{JMAX}$	175	°C
Package	Sub SMA	
Configuration	Single die	



Sub SMA

ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	VALUE	UNIT
Forward voltage @ $I_F=0.2\text{A}$	$V_F$	1.2	Volts
Power dissipation at $T_L=73^\circ\text{C}$ $T_A=25^\circ\text{C}$ (Note 1)	$P_{tot}$	2.3	Watts
		1.0	
Non-repetitive peak pulse power dissipation 100 $\mu\text{s}$ square pulse (Note 2)	$P_{ZSM}$	300	Watts
Non-repetitive peak pulse power dissipation 10/1000 $\mu\text{s}$ waveform (BZD27C10P to BZD27C100P)	$P_{RSM}$	150	Watts
Non-repetitive peak pulse power dissipation 10/1000 $\mu\text{s}$ waveform (BZD27C110P to BZD27C220P)	$P_{RSM}$	100	Watts
Operating and storage temperature range	$T_J, T_{STG}$	-55 to +175	°C

#### Notes:

1. Mounted on Cu-Pad size 5mm x 5mm
2.  $T_J=25^\circ\text{C}$  prior to surge

<b>THERMAL PERFORMANCE</b>			
<b>PARAMETER</b>	<b>SYMBOL</b>	<b>TYP.</b>	<b>UNIT</b>
Junction-to-lead thermal resistance	$R_{\theta JL}$	44	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	88	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	48	°C/W

**Thermal Performance Note:** Units mounted on PCB (5mm x 5mm Cu pad test board)

<b>ORDERING INFORMATION</b>		
<b>ORDERING CODE</b> (Note 1, 2)	<b>PACKAGE</b>	<b>PACKING</b>
BZD27CxxPHRUG	Sub SMA	1,800 / 7" Plastic reel (8mm tape)
BZD27CxxPHRVG	Sub SMA	3,000 / 7" Plastic reel (8mm tape)
BZD27CxxPHRTG	Sub SMA	7,500 / 13" Paper reel (8mm tape)
BZD27CxxPHMTG	Sub SMA	7,500 / 13" Plastic reel (8mm tape)
BZD27CxxPHRQG	Sub SMA	10,000 / 13" Paper reel (8mm tape)
BZD27CxxPHMQG	Sub SMA	10,000 / 13" Plastic reel (8mm tape)
BZD27CxxPHR3G	Sub SMA	1,800 / 7" Plastic reel (12mm tape)
BZD27CxxPHRFG	Sub SMA	3,000 / 7" Plastic reel (12mm tape)
BZD27CxxPHR2G	Sub SMA	7,500 / 13" Paper reel (12mm tape)
BZD27CxxPHM2G	Sub SMA	7,500 / 13" Plastic reel (12mm tape)
BZD27CxxPHRHG	Sub SMA	10,000 / 13" Paper reel (12mm tape)
BZD27CxxPHMHG	Sub SMA	10,000 / 13" Plastic reel (12mm tape)
BZD27CxxP RUG	Sub SMA	1,800 / 7" Plastic reel (8mm tape)
BZD27CxxP RVG	Sub SMA	3,000 / 7" Plastic reel (8mm tape)
BZD27CxxP RTG	Sub SMA	7,500 / 13" Paper reel (8mm tape)
BZD27CxxP MTG	Sub SMA	7,500 / 13" Plastic reel (8mm tape)
BZD27CxxP RQG	Sub SMA	10,000 / 13" Paper reel (8mm tape)
BZD27CxxP MQG	Sub SMA	10,000 / 13" Plastic reel (8mm tape)
BZD27CxxP R3G	Sub SMA	1,800 / 7" Plastic reel (12mm tape)
BZD27CxxP RFG	Sub SMA	3,000 / 7" Plastic reel (12mm tape)
BZD27CxxP R2G	Sub SMA	7,500 / 13" Paper reel (12mm tape)
BZD27CxxP M2G	Sub SMA	7,500 / 13" Plastic reel (12mm tape)
BZD27CxxP RHG	Sub SMA	10,000 / 13" Paper reel (12mm tape)
BZD27CxxP MHG	Sub SMA	10,000 / 13" Plastic reel (12mm tape)

**Note :**

- "xx" defines voltage from 10V (BZD27C10P) to 220V (BZD27C220P)
- "H" means AEC-Q101 qualified.

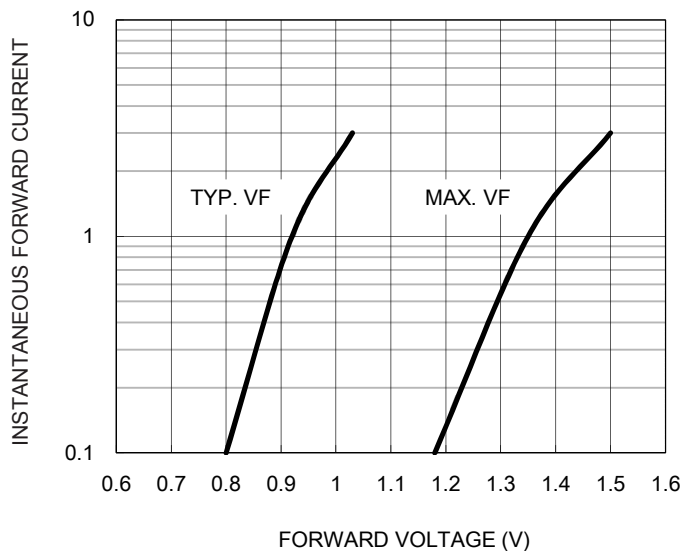
**ELECTRICAL SPECIFICATIONS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Part number	Marking code	Working Voltage (Note 1)			Differential Resistance		Temperature Coefficient		Test current	Reverse Current@ Reverse Voltage	
		$V_Z @ I_{ZT}$			$r_{diff} @ I_Z$		$ALPH_Z @ I_Z$		$I_{ZT}$	$I_R$	$V_R$
		V			$\Omega$		%/°C		mA	$\mu\text{A}$	V
		Min.	Nom.	Max.	Typ.	Max.	Max.	Max.		Max.	
BZD27C10P	E1	9.4	10	10.6	2	4	0.05	0.09	50	7	7.5
BZD27C11P	E2	10.4	11	11.6	4	7	0.05	0.10	50	4	8.2
BZD27C12P	E3	11.4	12.05	12.7	4	7	0.05	0.10	50	3	9.1
BZD27C13P	E4	12.4	13.25	14.1	5	10	0.05	0.10	50	2	10
BZD27C15P	E5	13.8	14.7	15.6	5	10	0.05	0.10	25	1	11
BZD27C16P	E6	15.3	16.2	17.1	6	15	0.06	0.11	25	1	12
BZD27C18P	E7	16.8	17.95	19.1	6	15	0.06	0.11	25	1	13
BZD27C20P	E8	18.8	20	21.2	6	15	0.06	0.11	25	1	15
BZD27C22P	E9	20.8	22.05	23.3	6	15	0.06	0.11	25	1	16
BZD27C24P	F0	22.8	24.2	25.6	7	15	0.06	0.11	25	1	18
BZD27C27P	F1	25.1	27	28.9	7	15	0.06	0.11	25	1	20
BZD27C30P	F2	28	30	32	8	15	0.06	0.11	25	1	22
BZD27C33P	F3	31	33	35	8	15	0.06	0.11	25	1	24
BZD27C36P	F4	34	36	38	21	40	0.06	0.11	10	1	27
BZD27C39P	F5	37	39	41	21	40	0.06	0.11	10	1	30
BZD27C43P	F6	40	43	46	24	45	0.07	0.12	10	1	33
BZD27C47P	F7	44	47	50	24	45	0.07	0.12	10	1	36
BZD27C51P	F8	48	51	54	25	60	0.07	0.12	10	1	39
BZD27C56P	F9	52	56	60	25	60	0.07	0.12	10	1	43
BZD27C62P	G0	58	62	66	25	80	0.08	0.13	10	1	47
BZD27C68P	G1	64	68	72	25	80	0.08	0.13	10	1	51
BZD27C75P	G2	70	74.5	79	30	100	0.08	0.13	10	1	56
BZD27C82P	G3	77	82	87	60	200	0.08	0.13	10	1	62
BZD27C91P	G4	85	90.5	96	60	200	0.08	0.13	5	1	68
BZD27C100P	G5	94	100	106	60	200	0.09	0.13	5	1	75
BZD27C110P	G6	104	110	116	80	250	0.09	0.13	5	1	82
BZD27C120P	G7	114	120.5	127	150	300	0.09	0.13	5	1	91
BZD27C130P	G	124	132.5	141	150	300	0.09	0.13	5	1	100
BZD27C150P	G9	138	147	156	150	300	0.09	0.13	5	1	110
BZD27C160P	H0	153	162	171	150	350	0.09	0.13	5	1	120
BZD27C180P	H1	168	179.5	191	280	450	0.09	0.13	5	1	130
BZD27C200P	H2	188	200	212	350	750	0.09	0.13	5	1	150
BZD27C220P	H3	208	220.5	233	430	900	0.09	0.13	5	1	160

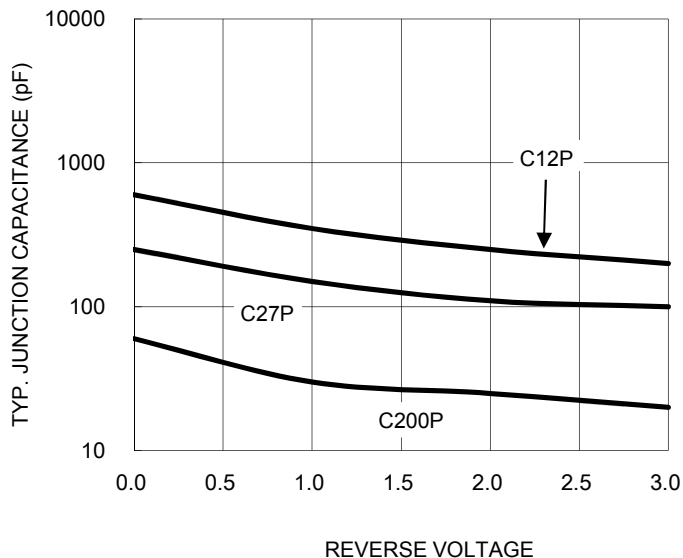
**CHARACTERISTICS CURVES**

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

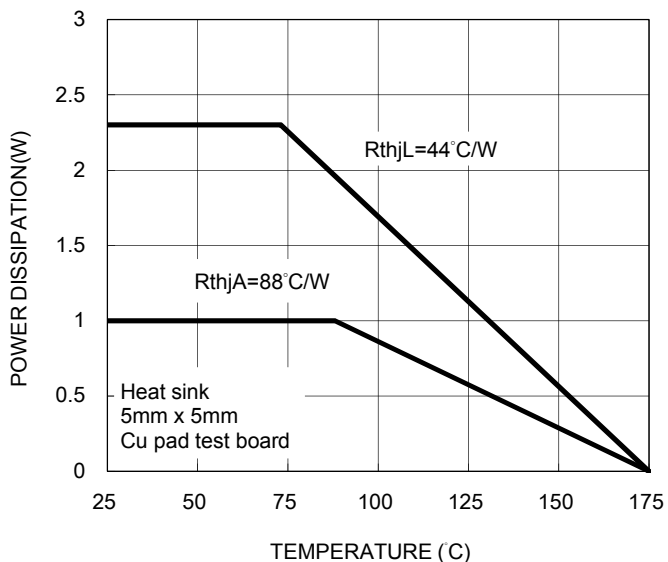
**Fig.1 TYPICAL FORWARD CHARACTERISTICS**



**Fig.2 TYP. DIODE CAPACITANCE vs REVERSE VOLTAGE**

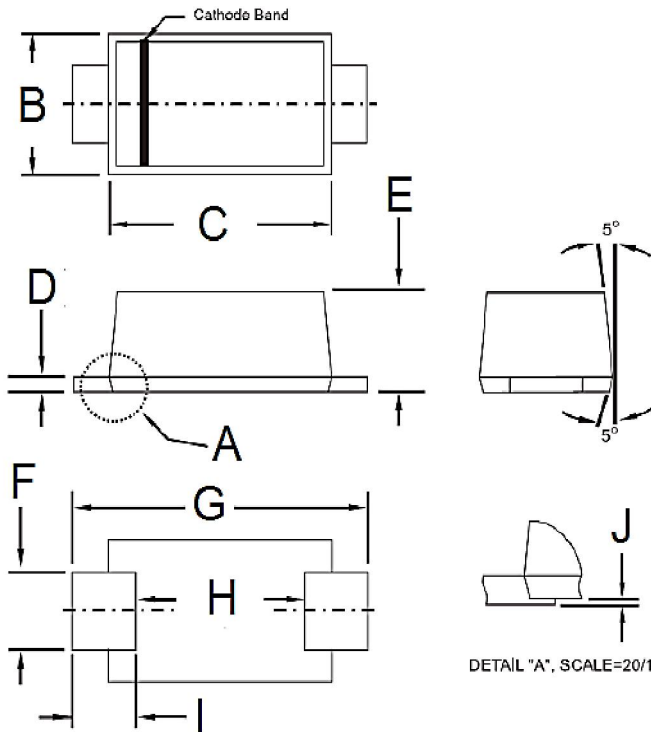


**Fig.3 POWER DISSIPATION v.s TEMPERATURE**



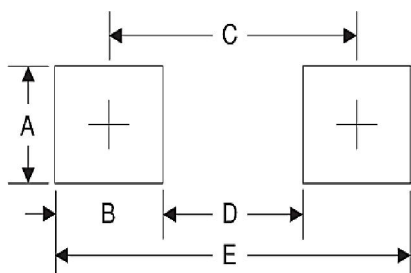
**PACKAGE OUTLINE DIMENSIONS**

Sub SMA



DIM.	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
B	1.70	1.90	0.067	0.075
C	2.70	2.90	0.106	0.114
D	0.16	0.30	0.006	0.012
E	1.23	1.43	0.048	0.056
F	0.80	1.20	0.031	0.047
G	3.40	3.80	0.134	0.150
H	2.45	2.60	0.096	0.102
I	0.35	0.85	0.014	0.033
J	0.00	0.10	0.000	0.004

**SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
A	1.4	0.055
B	1.2	0.047
C	3.1	0.122
D	1.9	0.075
E	4.3	0.169

**MARKING DIAGRAM**



- P/N = Marking Code
- G = Green compound Code
- YW = Date Code
- F = Factory Code

### **Notice**



Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.

## Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

-  [View BZD27C36P R3G on WIN SOURCE](#)
-  [Taiwan Semiconductor](#) Information

## Optimize Your Supply Chain with WIN SOURCE Solutions

-  Global Sourcing Solution
-  Obsolete Management
-  Cost Control Management
-  Shortage Management
-  Alternative Solution
-  Excess Inventory Management